Renesas Electronics America Inc - R5F21348WKFP#W4 Datasheet

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, I²C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	43
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21348wkfp-w4

1.2 Product List

Table 1.9 lists Product List for R8C/34W Group, Table 1.10 lists Product List for R8C/34X Group, Table 1.11 lists Product List for R8C/34Y Group, and Table 1.12 lists Product List for R8C/34Z Group.

Table 1.9 Product List for R8C/34W Group **Current of Jan 2013**

Part No.	ROM Capacity		RAM Capacity	Package Type	Remarks
	Program ROM	Data flash			
R5F21346WJFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0048KB-A	J version
R5F21347WJFP	48 Kbytes	1 Kbyte × 4	4 Kbytes	PLQP0048KB-A	
R5F21348WJFP	64 Kbytes	1 Kbyte × 4	6 Kbytes	PLQP0048KB-A	
R5F2134AWJFP	96 Kbytes	1 Kbyte × 4	8 Kbytes	PLQP0048KB-A	
R5F2134CWJFP	128 Kbytes	1 Kbyte × 4	10 Kbytes	PLQP0048KB-A	
R5F21346WKFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0048KB-A	K version
R5F21347WKFP	48 Kbytes	1 Kbyte × 4	4 Kbytes	PLQP0048KB-A	
R5F21348WKFP	64 Kbytes	1 Kbyte × 4	6 Kbytes	PLQP0048KB-A	
R5F2134AWKFP	96 Kbytes	1 Kbyte × 4	8 Kbytes	PLQP0048KB-A	
R5F2134CWKFP	128 Kbytes	1 Kbyte × 4	10 Kbytes	PLQP0048KB-A	

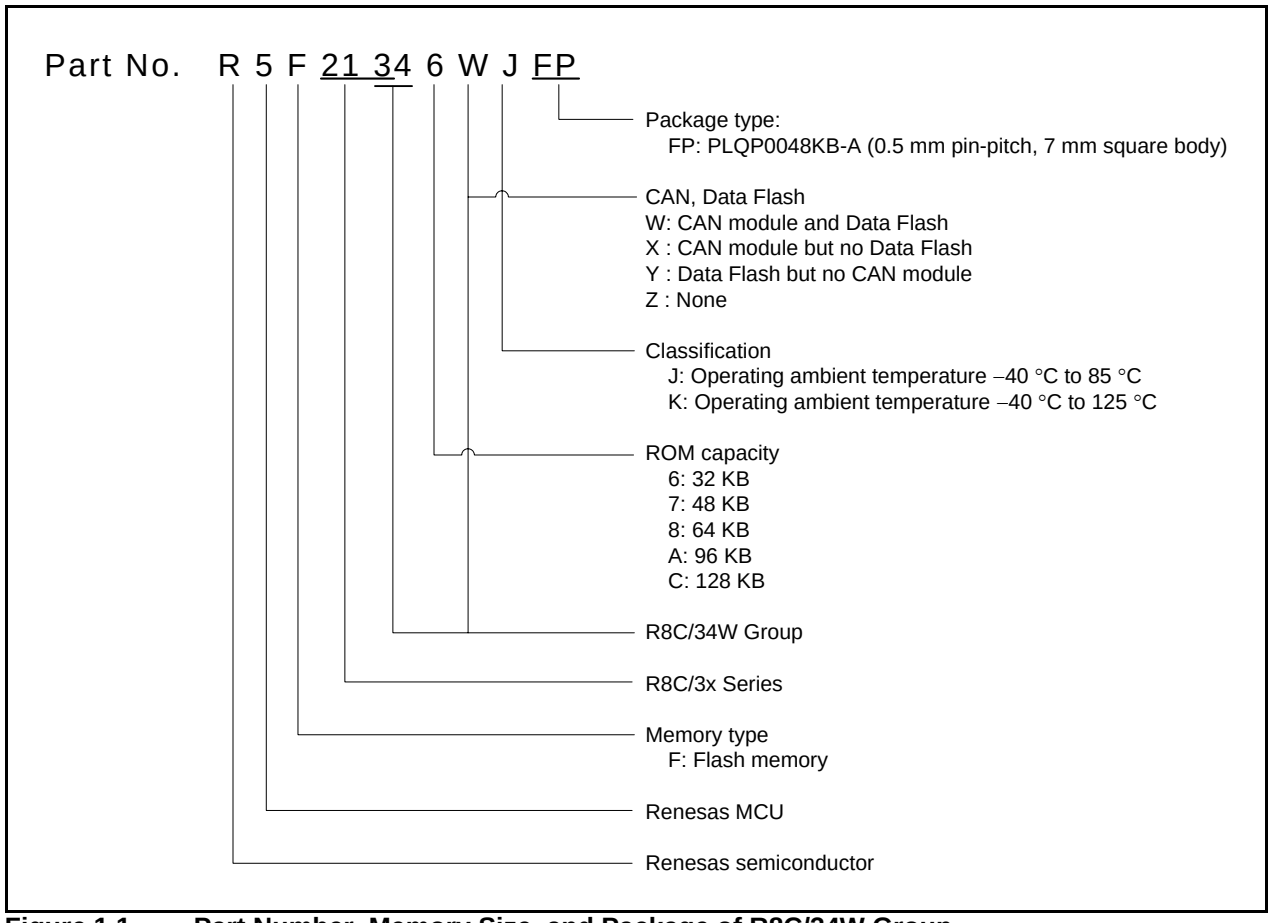


Figure 1.1 Part Number, Memory Size, and Package of R8C/34W Group

1.3 Block Diagram

Figure 1.5 shows a Block Diagram.

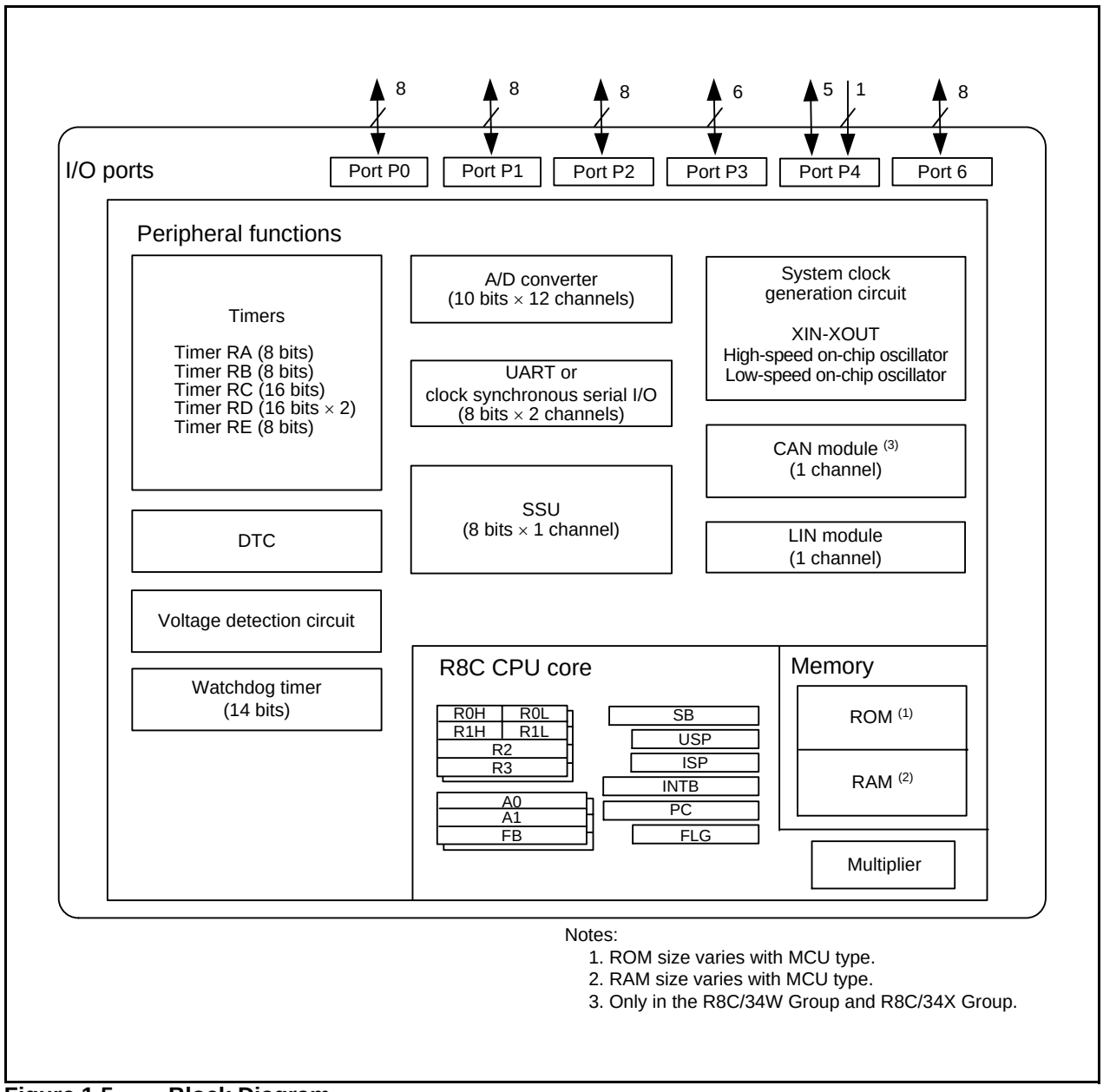
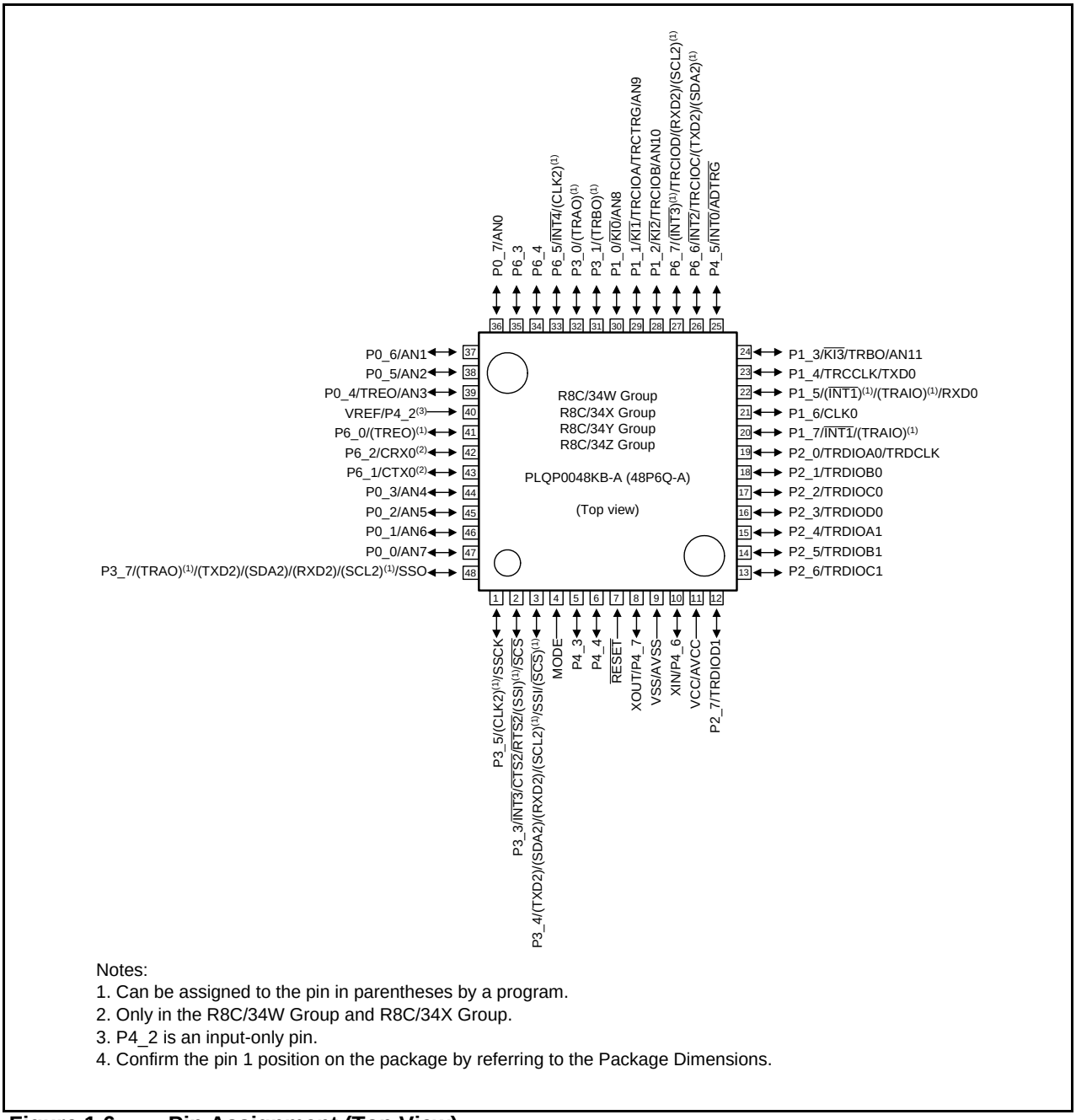


Figure 1.5 Block Diagram

1.4 Pin Assignment

Figure 1.6 shows Pin Assignment (Top View). Tables 1.13 and 1.14 outline the Pin Name Information by Pin Number.



Notes:
1. Can be assigned to the pin in parentheses by a program.
2. Only in the R8C/34W Group and R8C/34X Group.
3. P4_2 is an input-only pin.
4. Confirm the pin 1 position on the package by referring to the Package Dimensions.

Figure 1.6 Pin Assignment (Top View)

Table 1.13 Pin Name Information by Pin Number (1)

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	CAN Module (2)	A/D Converter Voltage Detection Circuit
1		P3_5			(CLK2) (1)	SSCK		
2		P3_3	$\overline{\text{INT3}}$		$\overline{\text{CTS2}}/\overline{\text{RTS2}}$	(SSI) (1)/$\overline{\text{SCS}}$		
3		P3_4			(TXD2)/(SDA2)/ (RXD2)/(SCL2) (1)	SSI/($\overline{\text{SCS}}$) (1)		
4	MODE							
5		P4_3						
6		P4_4						
7	$\overline{\text{RESET}}$							
8	XOUT	P4_7						
9	VSS/AVSS							
10	XIN	P4_6						
11	VCC/AVCC							
12		P2_7		TRDIOD1				
13		P2_6		TRDIOC1				
14		P2_5		TRDIOB1				
15		P2_4		TRDIOA1				
16		P2_3		TRDIOD0				
17		P2_2		TRDIOC0				
18		P2_1		TRDIOB0				
19		P2_0		TRDIOA0/ TRDCLK				
20		P1_7	$\overline{\text{INT1}}$	(TRAIO) (1)				
21		P1_6			CLK0			
22		P1_5	$\overline{\text{INT1}}$ (1)	(TRAIO) (1)	RXD0			
23		P1_4		TRCCLK	TXD0			
24		P1_3	$\overline{\text{KI3}}$	TRBO				AN11
25		P4_5	$\overline{\text{INT0}}$					$\overline{\text{ADTRG}}$
26		P6_6	$\overline{\text{INT2}}$	TRCIOC	(TXD2)/(SDA2) (1)			

Notes:
1. This can be assigned to the pin in parentheses by a program.
2. Only for the R8C/34W Group and R8C/34X Group.

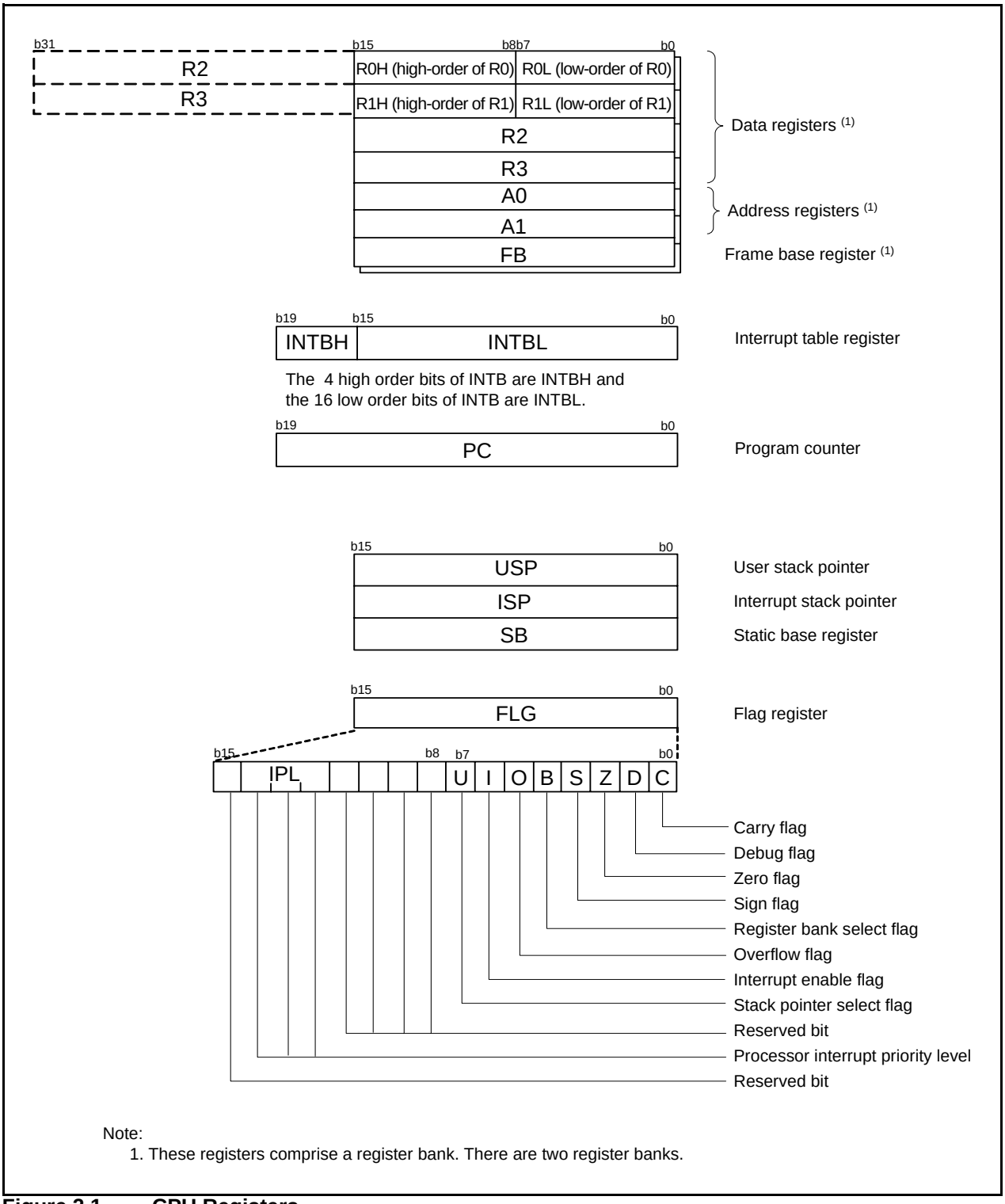
Table 1.14 Pin Name Information by Pin Number (2)

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	CAN Module (2)	A/D Converter Voltage Detection Circuit
27		P6_7	$\overline{\text{INT3}}$ (1)	TRCIOD	(RXD2)/(SCL2) (1)			
28		P1_2	$\overline{\text{KI2}}$	TRCIOB				AN10
29		P1_1	$\overline{\text{KI1}}$	TRCIOA/ TRCTRG				AN9
30		P1_0	$\overline{\text{KI0}}$					AN8
31		P3_1		(TRBO) (1)				
32		P3_0		(TRAO) (1)				
33		P6_5	$\overline{\text{INT4}}$		(CLK2) (1)			
34		P6_4						
35		P6_3						
36		P0_7						AN0
37		P0_6						AN1
38		P0_5						AN2
39		P0_4		TREO				AN3
40		P4_2						VREF
41		P6_0		(TREO) (1)				
42		P6_2					CRX0 (2)	
43		P6_1					CTX0 (2)	
44		P0_3						AN4
45		P0_2						AN5
46		P0_1						AN6
47		P0_0						AN7
48		P3_7		(TRAO) (1)	(TXD2)/(SDA2)/ (RXD2)/(SCL2) (1)	SSO		

Notes:
1. This can be assigned to the pin in parentheses by a program.
2. Only for the R8C/34W Group and R8C/34X Group.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

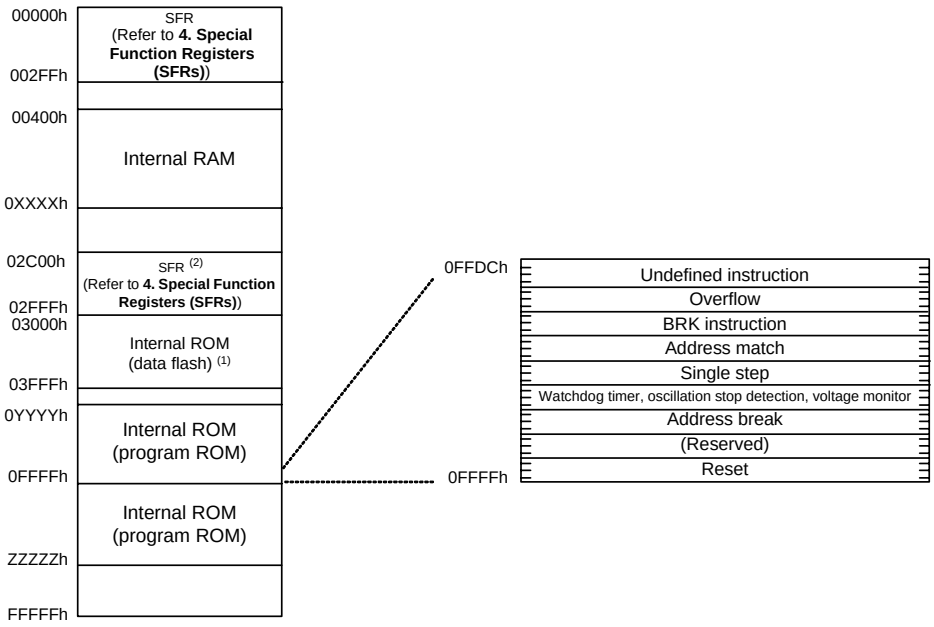


Note:
1. These registers comprise a register bank. There are two register banks.

Figure 2.1 CPU Registers

3.3 R8C/34Y Group

Figure 3.3 is a Memory Map of R8C/34Y Group. The R8C/34Y Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM area is allocated addresses 04000h to 0FFFFh.
The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.
The internal ROM (data flash) is allocated addresses 03000h to 03FFFh.
The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 4-Kbyte internal RAM area is allocated addresses 00400h to 013FFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.
Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh (the SFR areas for the DTC and other modules). Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.



Notes:
1. The Data Flash memory indicates blocks A (1 Kbyte), B (1 Kbyte), C (1 Kbyte), and D (1 Kbyte).
2. The SFR areas for the DTC and other modules are allocated to addresses 02C00h to 02FFFh.
3. The blank areas are reserved and cannot be accessed by users.

Part Number	Internal ROM			Internal RAM	
	Size	Address 0YYYYh	Address ZZZZZh	Size	Address 0XXXXh
R5F21346YJFP, R5F21346YKFP	32 Kbytes	08000h	—	2.5 Kbytes	00DFFh
R5F21347YJFP, R5F21347YKFP	48 Kbytes	04000h	—	4 Kbytes	013FFh
R5F21348YJFP, R5F21348YKFP	64 Kbytes	04000h	13FFFh	6 Kbytes	01BFFh
R5F2134AYJFP, R5F2134AYKFP	96 Kbytes	04000h	1BFFFh	8 Kbytes	023FFh
R5F2134CYJFP, R5F2134CYKFP	128 Kbytes	04000h	23FFFh	10 Kbytes	02BFFh

Figure 3.3 Memory Map of R8C/34Y Group

Table 4.9 SFR Information (9) (1)

Address	Register	Symbol	After reset
2C00h	DTC Transfer Vector Area		XXh
2C01h	DTC Transfer Vector Area		XXh
2C02h	DTC Transfer Vector Area		XXh
2C03h	DTC Transfer Vector Area		XXh
2C04h	DTC Transfer Vector Area		XXh
2C05h			
2C06h			
2C07h			
2C08h	DTC Transfer Vector Area		XXh
2C09h	DTC Transfer Vector Area		XXh
2C0Ah	DTC Transfer Vector Area		XXh
:	DTC Transfer Vector Area		XXh
:	DTC Transfer Vector Area		XXh
2C3Ah			
2C3Bh			
2C3Ch			
2C3Dh			
2C3Eh			
2C3Fh			
2C40h	DTC Control Data 0	DTCD0	XXh
2C41h			XXh
2C42h			XXh
2C43h			XXh
2C44h			XXh
2C45h			XXh
2C46h			XXh
2C47h			XXh
2C48h	DTC Control Data 1	DTCD1	XXh
2C49h			XXh
2C4Ah			XXh
2C4Bh			XXh
2C4Ch			XXh
2C4Dh			XXh
2C4Eh			XXh
2C4Fh			XXh
2C50h	DTC Control Data 2	DTCD2	XXh
2C51h			XXh
2C52h			XXh
2C53h			XXh
2C54h			XXh
2C55h			XXh
2C56h			XXh
2C57h			XXh
2C58h	DTC Control Data 3	DTCD3	XXh
2C59h			XXh
2C5Ah			XXh
2C5Bh			XXh
2C5Ch			XXh
2C5Dh			XXh
2C5Eh			XXh
2C5Fh			XXh
2C60h	DTC Control Data 4	DTCD4	XXh
2C61h			XXh
2C62h			XXh
2C63h			XXh
2C64h			XXh
2C65h			XXh
2C66h			XXh
2C67h			XXh
2C68h	DTC Control Data 5	DTCD5	XXh
2C69h			XXh
2C6Ah			XXh
2C6Bh			XXh
2C6Ch			XXh
2C6Dh			XXh
2C6Eh			XXh
2C6Fh			XXh

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.10 SFR Information (10) (1)

Address	Register	Symbol	After reset
2C70h	DTC Control Data 6	DTCD6	XXh
2C71h			XXh
2C72h			XXh
2C73h			XXh
2C74h			XXh
2C75h			XXh
2C76h			XXh
2C77h			XXh
2C78h	DTC Control Data 7	DTCD7	XXh
2C79h			XXh
2C7Ah			XXh
2C7Bh			XXh
2C7Ch			XXh
2C7Dh			XXh
2C7Eh			XXh
2C7Fh			XXh
2C80h	DTC Control Data 8	DTCD8	XXh
2C81h			XXh
2C82h			XXh
2C83h			XXh
2C84h			XXh
2C85h			XXh
2C86h			XXh
2C87h			XXh
2C88h	DTC Control Data 9	DTCD9	XXh
2C89h			XXh
2C8Ah			XXh
2C8Bh			XXh
2C8Ch			XXh
2C8Dh			XXh
2C8Eh			XXh
2C8Fh			XXh
2C90h	DTC Control Data 10	DTCD10	XXh
2C91h			XXh
2C92h			XXh
2C93h			XXh
2C94h			XXh
2C95h			XXh
2C96h			XXh
2C97h			XXh
2C98h	DTC Control Data 11	DTCD11	XXh
2C99h			XXh
2C9Ah			XXh
2C9Bh			XXh
2C9Ch			XXh
2C9Dh			XXh
2C9Eh			XXh
2C9Fh			XXh
2CA0h	DTC Control Data 12	DTCD12	XXh
2CA1h			XXh
2CA2h			XXh
2CA3h			XXh
2CA4h			XXh
2CA5h			XXh
2CA6h			XXh
2CA7h			XXh
2CA8h	DTC Control Data 13	DTCD13	XXh
2CA9h			XXh
2CAAh			XXh
2CABh			XXh
2CACh			XXh
2CADh			XXh
2CAEh			XXh
2CAFh			XXh

X: Undefined
Note:
1. The blank areas are reserved and cannot be accessed by users.

Table 4.13 SFR Information (13) (1)

Address	Register	Symbol	After reset
2E30h	CAN0 Mailbox 3 : Message ID	C0MB3	XXh
2E31h			XXh
2E32h			XXh
2E33h			XXh
2E34h			
2E35h	CAN0 Mailbox 3 : Data length		XXh
2E36h	CAN0 Mailbox 3 : Data field		XXh
2E37h			XXh
2E38h			XXh
2E39h			XXh
2E3Ah			XXh
2E3Bh			XXh
2E3Ch			XXh
2E3Dh			XXh
2E3Eh	CAN0 Mailbox3 : Time stamp		XXh
2E3Fh			XXh
2E40h	CAN0 Mailbox4 : Message ID	C0MB4	XXh
2E41h			XXh
2E42h			XXh
2E43h			XXh
2E44h			
2E45h	CAN0 Mailbox4 : Data length		XXh
2E46h	CAN0 Mailbox4 : Data field		XXh
2E47h			XXh
2E48h			XXh
2E49h			XXh
2E4Ah			XXh
2E4Bh			XXh
2E4Ch			XXh
2E4Dh			XXh
2E4Eh	CAN0 Mailbox4 : Time stamp		XXh
2E4Fh			XXh
2E50h	CAN0 Mailbox5 : Message ID	C0MB5	XXh
2E51h			XXh
2E52h			XXh
2E53h			XXh
2E54h			
2E55h	CAN0 Mailbox5 : Data length		XXh
2E56h	CAN0 Mailbox5 : Data field		XXh
2E57h			XXh
2E58h			XXh
2E59h			XXh
2E5Ah			XXh
2E5Bh			XXh
2E5Ch			XXh
2E5Dh			XXh
2E5Eh	CAN0 Mailbox5 : Time stamp		XXh
2E5Fh			XXh
2E60h	CAN0 Mailbox6 : Message ID	C0MB6	XXh
2E61h			XXh
2E62h			XXh
2E63h			XXh
2E64h			
2E65h	CAN0 Mailbox6 : Data length		XXh
2E66h	CAN0 Mailbox6 : Data field		XXh
2E67h			XXh
2E68h			XXh
2E69h			XXh
2E6Ah			XXh
2E6Bh			XXh
2E6Ch			XXh
2E6Dh			XXh
2E6Eh	CAN0 Mailbox6 : Time stamp		XXh
2E6Fh			XXh

X: Undefined
Note:
1. The blank areas are reserved and cannot be accessed by users.

Table 4.14 SFR Information (14) (1)

Address	Register	Symbol	After reset
2E70h	CAN0 Mailbox7 : Message ID	C0MB7	XXh
2E71h			XXh
2E72h			XXh
2E73h			XXh
2E74h			
2E75h	CAN0 Mailbox7 : Data length		XXh
2E76h	CAN0 Mailbox7 : Data field		XXh
2E77h			XXh
2E78h			XXh
2E79h			XXh
2E7Ah			XXh
2E7Bh			XXh
2E7Ch			XXh
2E7Dh			XXh
2E7Eh	CAN0 Mailbox7 : Time stamp		XXh
2E7Fh			XXh
2E80h	CAN0 Mailbox8 : Message ID	C0MB8	XXh
2E81h			XXh
2E82h			XXh
2E83h			XXh
2E84h			
2E85h	CAN0 Mailbox8 : Data length		XXh
2E86h	CAN0 Mailbox8 : Data field		XXh
2E87h			XXh
2E88h			XXh
2E89h			XXh
2E8Ah			XXh
2E8Bh			XXh
2E8Ch			XXh
2E8Dh			XXh
2E8Eh	CAN0 Mailbox8 : Time stamp		XXh
2E8Fh			XXh
2E90h	CAN0 Mailbox9 : Message ID	C0MB9	XXh
2E91h			XXh
2E92h			XXh
2E93h			XXh
2E94h			
2E95h	CAN0 Mailbox9 : Data length		XXh
2E96h	CAN0 Mailbox9 : Data field		XXh
2E97h			XXh
2E98h			XXh
2E99h			XXh
2E9Ah			XXh
2E9Bh			XXh
2E9Ch			XXh
2E9Dh			XXh
2E9Eh	CAN0 Mailbox9 : Time stamp		XXh
2E9Fh			XXh
2EA0h	CAN0 Mailbox10 : Message ID	C0MB10	XXh
2EA1h			XXh
2EA2h			XXh
2EA3h			XXh
2EA4h			
2EA5h	CAN0 Mailbox10 : Data length		XXh
2EA6h	CAN0 Mailbox10 : Data field		XXh
2EA7h			XXh
2EA8h			XXh
2EA9h			XXh
2EAAh			XXh
2EABh			XXh
2EACh			XXh
2EADh			XXh
2EAEh	CAN0 Mailbox10 : Time stamp		XXh
2EAFh			XXh

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.15 SFR Information (15) (1)

Address	Register	Symbol	After reset
2EB0h	CAN0 Mailbox11 : Message ID	C0MB11	XXh
2EB1h			XXh
2EB2h			XXh
2EB3h			XXh
2EB4h			
2EB5h	CAN0 Mailbox11 : Data length		XXh
2EB6h	CAN0 Mailbox11 : Data field		XXh
2EB7h			XXh
2EB8h			XXh
2EB9h			XXh
2EBAh			XXh
2EBBh			XXh
2EBCh			XXh
2EBDh			XXh
2EBEh	CAN0 Mailbox11 : Time stamp		XXh
2EBFh			XXh
2EC0h	CAN0 Mailbox12 : Message ID	C0MB12	XXh
2EC1h			XXh
2EC2h			XXh
2EC3h			XXh
2EC4h			
2EC5h	CAN0 Mailbox12 : Data length		XXh
2EC6h	CAN0 Mailbox12 : Data field		XXh
2EC7h			XXh
2EC8h			XXh
2EC9h			XXh
2ECAh			XXh
2ECBh			XXh
2ECCh			XXh
2ECDh			XXh
2ECEh	CAN0 Mailbox12 : Time stamp		XXh
2ECFh			XXh
2ED0h	CAN0 Mailbox13 : Message ID	C0MB13	XXh
2ED1h			XXh
2ED2h			XXh
2ED3h			XXh
2ED4h			
2ED5h	CAN0 Mailbox13 : Data length		XXh
2ED6h	CAN0 Mailbox13 : Data field		XXh
2ED7h			XXh
2ED8h			XXh
2ED9h			XXh
2EDAh			XXh
2EDBh			XXh
2EDCh			XXh
2EDDh			XXh
2EDEh	CAN0 Mailbox13 : Time stamp		XXh
2EDFh			XXh
2EE0h	CAN0 Mailbox14 : Message ID	C0MB14	XXh
2EE1h			XXh
2EE2h			XXh
2EE3h			XXh
2EE4h			
2EE5h	CAN0 Mailbox14 : Data length		XXh
2EE6h	CAN0 Mailbox14 : Data field		XXh
2EE7h			XXh
2EE8h			XXh
2EE9h			XXh
2EEAh			XXh
2EEBh			XXh
2EECh			XXh
2EEDh			XXh
2EEEh	CAN0 Mailbox14 : Time stamp		XXh
2EEFh			XXh

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.16 SFR Information (16) (1)

Address	Register	Symbol	After reset
2EF0h	CAN0 Mailbox15 : Message ID	C0MB15	XXh
2EF1h			XXh
2EF2h			XXh
2EF3h			XXh
2EF4h			
2EF5h	CAN0 Mailbox15 : Data length		XXh
2EF6h	CAN0 Mailbox15 : Data field		XXh
2EF7h			XXh
2EF8h			XXh
2EF9h			XXh
2EFAh			XXh
2EFBh			XXh
2EFCh			XXh
2EFDh			XXh
2EFEh	CAN0 Mailbox15 : Time stamp		XXh
2EFFh			XXh
2F00h			
2F01h			
2F02h			
2F03h			
2F04h			
2F05h			
2F06h			
2F07h			
2F08h			
2F09h			
2F0Ah			
2F0Bh			
2F0Ch			
2F0Dh			
2F0Eh			
2F0Fh			
2F10h	CAN0 Mask Register 0	C0MKR0	XXh
2F11h			XXh
2F12h			XXh
2F13h			XXh
2F14h	CAN0 Mask Register 1	C0MKR1	XXh
2F15h			XXh
2F16h			XXh
2F17h			XXh
2F18h	CAN0 Mask Register 2	C0MKR2	XXh
2F19h			XXh
2F1Ah			XXh
2F1Bh			XXh
2F1Ch	CAN0 Mask Register 3	C0MKR3	XXh
2F1Dh			XXh
2F1Eh			XXh
2F1Fh			XXh
2F20h	CAN0 FIFO Received ID Compare Register 0	C0FIDCR0	XXh
2F21h			XXh
2F22h			XXh
2F23h			XXh
2F24h	CAN0 FIFO Received ID Compare Register 1	C0FIDCR1	XXh
2F25h			XXh
2F26h			XXh
2F27h			XXh
2F28h			
2F29h			
2F2Ah	CAN0 Mask Invalid Register	C0MKIVLR	XXh
2F2Bh			XXh
2F2Ch			
2F2Dh			
2F2Eh	CAN0 Mailbox Interrupt Enable Register	C0MIER	XXh
2F2Fh			XXh
2F30h	CAN0 Message Control Register 0	C0MCTL0	00h
2F31h	CAN0 Message Control Register 1	C0MCTL1	00h
2F32h	CAN0 Message Control Register 2	C0MCTL2	00h
2F33h	CAN0 Message Control Register 3	C0MCTL3	00h
2F34h	CAN0 Message Control Register 4	C0MCTL4	00h
2F35h	CAN0 Message Control Register 5	C0MCTL5	00h
2F36h	CAN0 Message Control Register 6	C0MCTL6	00h
2F37h	CAN0 Message Control Register 7	C0MCTL7	00h
2F38h	CAN0 Message Control Register 8	C0MCTL8	00h
2F39h	CAN0 Message Control Register 9	C0MCTL9	00h
2F3Ah	CAN0 Message Control Register 10	C0MCTL10	00h

X: Undefined

Note:

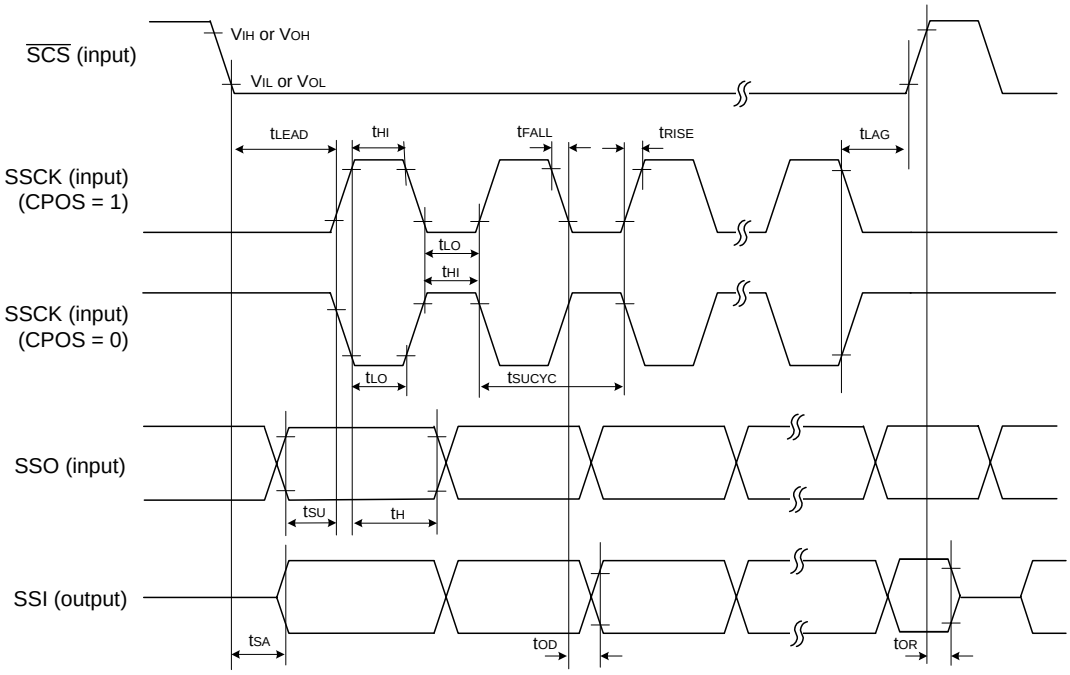
1. The blank areas are reserved and cannot be accessed by users.

Table 5.4 A/D Converter Characteristics

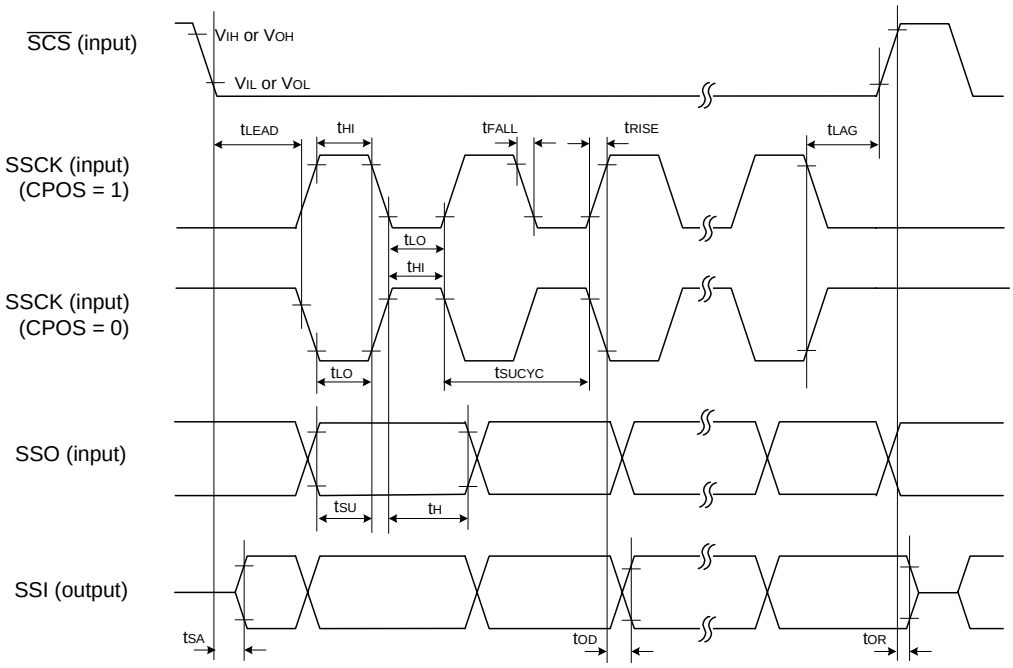
Symbol	Parameter		Conditions		Standard			Unit
					Min.	Typ.	Max.	
–	Resolution		V_{ref} = AV_{CC}		–	–	10	Bit
–	Absolute accuracy	10-bit mode	V_{ref} = AV_{CC} = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±3	LSB
			V_{ref} = AV_{CC} = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±5	LSB
		8-bit mode	V_{ref} = AV_{CC} = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±2	LSB
			V_{ref} = AV_{CC} = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±2	LSB
ϕAD	A/D conversion clock		4.0 ≤ V_{ref} = AV_{CC} = ≤ 5.5 (2)		2	–	20	MHz
			2.7 ≤ V_{ref} = AV_{CC} = ≤ 5.5 (2)		2	–	10	MHz
–	Tolerance level impedance				–	3	–	kΩ
I_{vref}	V_{ref} current		V_{CC} = 5.0 V, XIN = f1 = ϕAD = 20 MHz		–	45	–	µA
t_{CONV}	Conversion time	10-bit mode	V_{ref} = AV_{CC} = 5.0 V, ϕAD = 20 MHz		2.2	–	–	µs
		8-bit mode	V_{ref} = AV_{CC} = 5.0 V, ϕAD = 20 MHz		2.2	–	–	µs
t_{SAMP}	Sampling time		ϕAD = 20 MHz		0.8	–	–	µs
V_{ref}	Reference voltage				2.7	–	AV_{CC}	V
V_{IA}	Analog input voltage (3)				0	–	V_{ref}	V
OCVREF	On-chip reference voltage		2 MHz ≤ ϕAD ≤ 4 MHz		1.14	1.34	1.54	V

Notes:
1. V_{CC}/AV_{CC} = V_{ref} = 2.7 to 5.5 V, V_{SS} = 0 V at T_{opr} = –40 to 85°C (J version) / –40 to 125°C (K version), unless otherwise specified.
2. The A/D conversion result will be undefined in wait mode, stop mode, when the flash memory stops, and in low-consumption current mode. Do not perform A/D conversion in these states or transition to these states during A/D conversion.
3. When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

4-Wire Bus Communication Mode, Slave, CPHS = 1



4-Wire Bus Communication Mode, Slave, CPHS = 0



CPHS, CPOS: Bits in SSMR register

Figure 5.5 I/O Timing of SSU (Slave)

Table 5.16 Electrical Characteristics (2) [3.3 V ≤ Vcc ≤ 5.5 V]
(Topr = –40 to 85°C (J version), unless otherwise specified.)

Symbol	Parameter	Condition		Standard			Unit
				Min.	Typ.	Max.	
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open, other pins are Vss	High-speed clock mode (1)	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	7.0	15	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	5.6	12.5	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	3.6	–	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	–	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	2.2	–	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	1.5	–	mA
		High-speed on-chip oscillator mode (1)	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	–	7.0	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	–	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	–	90	180	µA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	15	110	µA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	5	100	µA
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	–	2.0	5.0	µA
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	–	15.0	–	µA

Note:
1. The typical value (Typ.) indicates the current value when the CPU and the memory operate.
The maximum value (Max.) indicates the current when the CPU, the memory, and the peripheral functions operate and the flash memory is programmed/erased.

Table 5.20 Serial Interface

Symbol	Parameter	Condition	Standard		Unit
			Min.	Max.	
$t_{c(CK)}$	CLKi input cycle time	When external clock selected	200	–	ns
$t_{W(CKH)}$	CLKi input “H” width		100	–	ns
$t_{W(CKL)}$	CLKi input “L” width		100	–	ns
$t_{d(C-Q)}$	TXDi output delay time		–	90	ns
$t_{h(C-Q)}$	TXDi hold time		0	–	ns
$t_{su(D-C)}$	RXDi input setup time		10	–	ns
$t_{h(C-D)}$	RXDi input hold time		90	–	ns
$t_{d(C-Q)}$	TXDi output delay time	When internal clock selected	–	10	ns
$t_{su(D-C)}$	RXDi input setup time		90	–	ns
$t_{h(C-D)}$	RXDi input hold time		90	–	ns

i = 0, 2

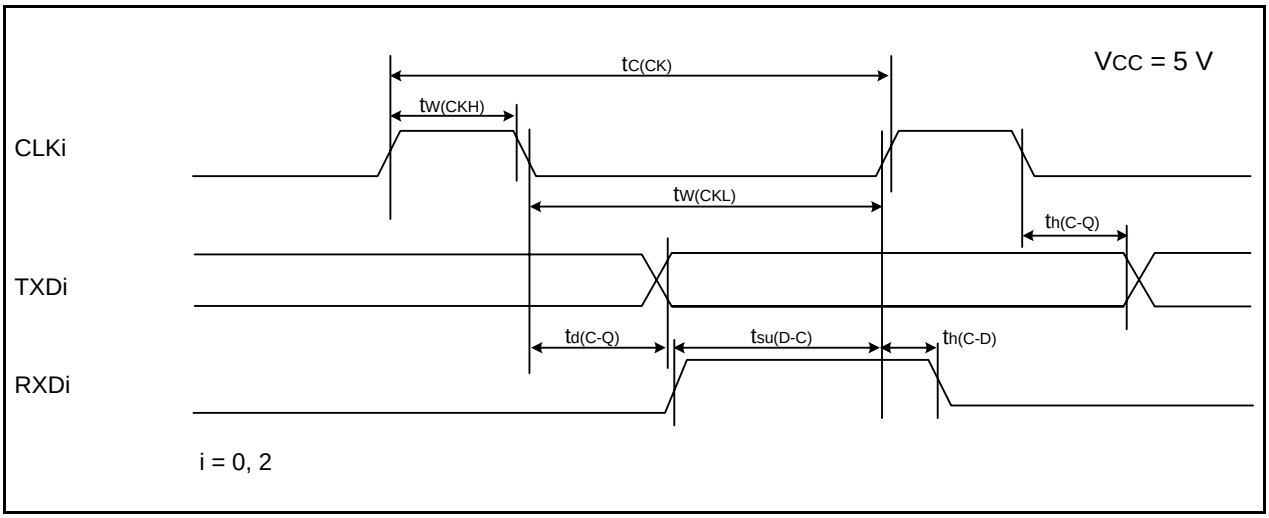


Figure 5.9 Serial Interface Timing Diagram when VCC = 5 V

Table 5.21 External Interrupt $\overline{INTi}$ (i = 0 to 4) Input, Key Input Interrupt $\overline{KIi}$ (i = 0 to 3)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{W(INH)}$	$\overline{INTi}$ input “H” width, $\overline{KIi}$ input “H” width	250 (1)	–	ns
$t_{W(INL)}$	$\overline{INTi}$ input “L” width, $\overline{KIi}$ input “L” width	250 (2)	–	ns

Notes:
1. When selecting the digital filter by the $\overline{INTi}$ input filter select bit, use an $\overline{INTi}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{INTi}$ input filter select bit, use an $\overline{INTi}$ input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

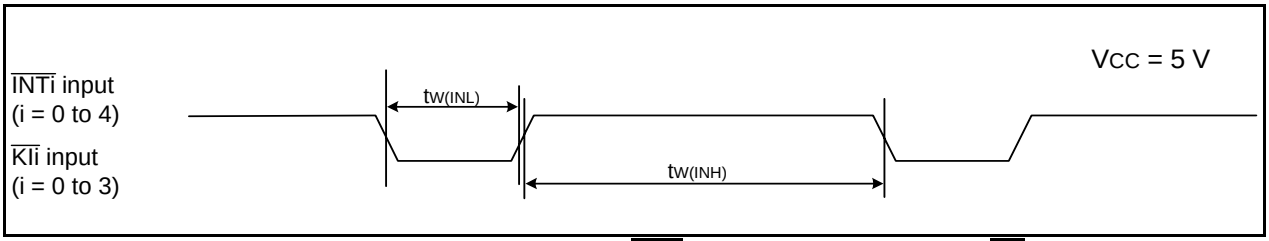


Figure 5.10 Input Timing for External Interrupt $\overline{INTi}$ and Key Input Interrupt $\overline{KIi}$ when Vcc = 5 V

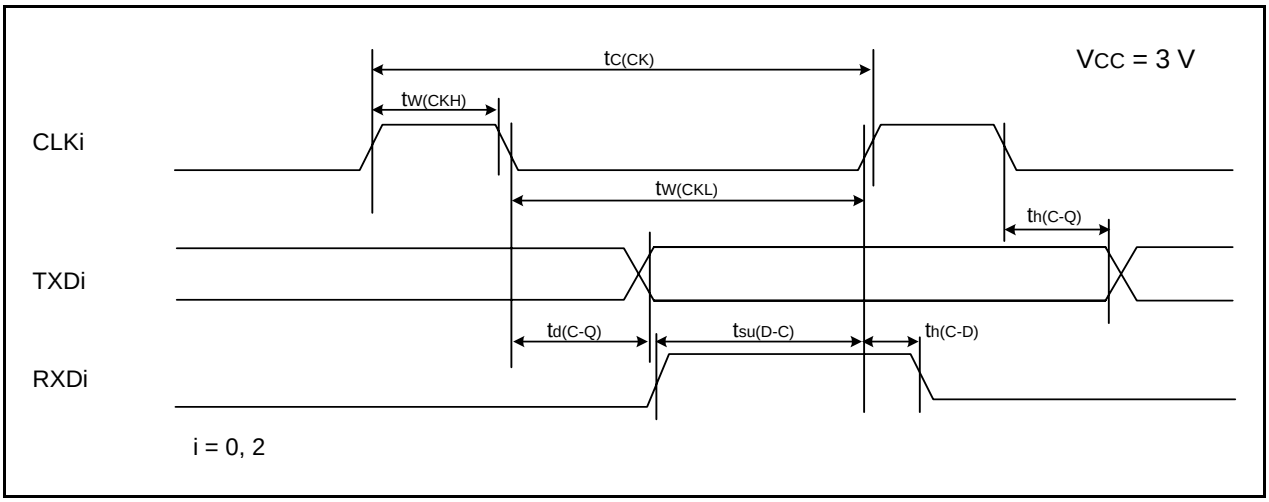


Figure 5.13 Serial Interface Timing Diagram when Vcc = 3 V

Table 5.28 External Interrupt $\overline{\text{INTi}}$ (i = 0 to 4) Input, Key Input Interrupt $\overline{\text{KIi}}$ (i = 0 to 3)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{W(INH)}$	$\overline{\text{INTi}}$ input “H” width, $\overline{\text{KIi}}$ input “H” width	380 (1)	–	ns
$t_{W(INL)}$	$\overline{\text{INTi}}$ input “L” width, $\overline{\text{KIi}}$ input “L” width	380 (2)	–	ns

Notes:
1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

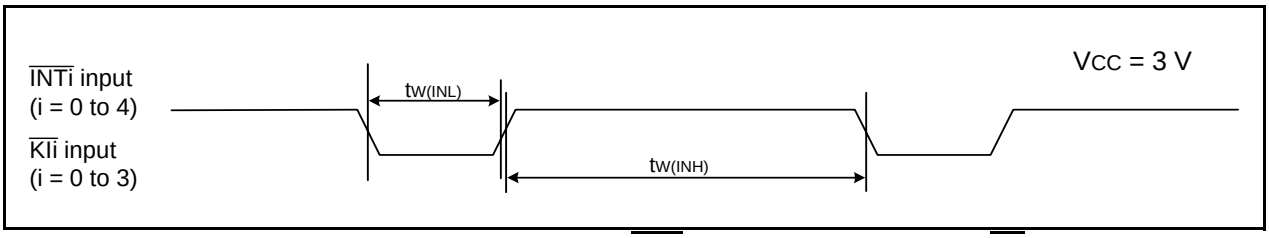


Figure 5.14 Input Timing for External Interrupt $\overline{\text{INTi}}$ and Key Input Interrupt $\overline{\text{KIi}}$ when Vcc = 3 V

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

   Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

   — The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
   "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.
   "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.
   Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics.
6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

RENESAS

SALES OFFICES Renesas Electronics Corporation http://www.renesas.com

Refer to "http://www.renesas.com/" for the latest and detailed information.

Renesas Electronics America Inc.
2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A.
Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada
Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China
Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.
11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141

Colophon 2.2